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THE UNITED STATES PATENT AND TRADEMARK OFFICE

e Application of: Andrew Marshall

Docket No.: TI-31484

Serial No.: 10/007,332

Art Unit: 2815

Filed: 11/08/01

Examiner: Warren, M. E.

Title: Thermal Coupling of Matched SOI Device Bodies

APPELLANT'S BRIEF UNDER 37 CFR 1.192

December 15, 2004

Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Dear Sir:

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service on 12-15-04

as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450.

Karen Vurd 12-15-04

Karen Vertz Date

Pursuant to the Advisory Action mailed 09/20/2004, the Appellant submits this Appellant's Brief in triplicate. The Commissioner is hereby requested and authorized to charge any fees necessary for the filing of the enclosed papers to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.

TI-31484